

# E263-Z30-AAD1

Edge Server - AMD EPYC™ 9004 - 2U UP 2 x PCle Gen5 GPUs

# Al Training # Al Inference # Visual Computing # Networking # Edge # Hybrid/Private Cloud Server

- Supports up to 2 x Dual slot Gen5 GPUs
- Single AMD EPYC™ 9004 Series Processors (with AMD 3D V-Cache™ Technology)
- 12-Channel DDR5 RDIMM, 12 x DIMMs
- Dual ROM Architecture
- 1 x 1Gb/s LAN port via Intel® I210-AT
- 2 x 2.5" Gen4 NVMe/SATA/SAS hot-swappable bays on the rear side
- 1 x M.2 slot with PCIe Gen3 x4 interface
- 2 x FHFL PCIe Gen5 x16 slots for GPUs
- 2 x OCP 3.0 Gen5 x16 slots
- 1+1 1600W 80 PLUS Platinum redundant power supplies







## Dimensions (WxHxD, mm)

2U 438 x 87.5 x 520

## Motherboard

MZ33-DC0

#### CPU

AMD EPYC™ 9004 Series Processors
AMD EPYC™ 9004 Series Processors with AMD 3D V-Cache™
Technology
Single processor, 5nm technology
\*Up to 128 cores, 256 threads
cTDP up to 300W at ambient 35°C

\*cTDP supported up to 400W under limited thermal conditions. Please contact technical support for more details.

## Socket

1 x LGA 6096 Socket SP5

#### Chipset

System on Chip

## Memory

12 x DIMM slots DDR5 memory supported only 12-Channel memory architecture RDIMM up to 96GB supported 3DS RDIMM up to 256GB supported Memory speed: Up to 4800 MT/s

## LAN

## Rear side:

1 x 1Gb/s LAN port (1 x Intel® I210-AT) Supports NCSI function

1 x 10/100/1000 Mbps Management LAN

## Video

Integrated in Aspeed® AST2600 2D Video Graphic Adapter with PCIe bus interface 1920x1200@60Hz 32bpp

## Storage

#### Rear side:

2 x 2.5" Gen4 NVMe/SATA/SAS hot-swappable bays

## SAS card is required for SAS devices support

#### SAS

Depends on SAS add-in cards

#### RAID

N/A

#### **Expansion Slots**

## Riser Card CRS201M:

- 1 x PCle x16 (Gen5 x16) FHFL slot, for GPUs

## Riser Card CRS201H:

- 1 x PCle x16 (Gen5 x16) FHFL slot, for GPUs

2 x OCP 3.0 slots with PCIe Gen5 x16 bandwidth Support NCSI function

- 1 x M.2 slot:
- M-key
- PCIe Gen3 x4
- Supports 2280/22110 cards

Note: Please refer to optional parts for H100/A100/MI210 power cables.

## Internal I/O

1 x TPM header

## Front I/O

2 x USB 3.2 Gen1

- 1 x Power button with LED
- 1 x ID button with LED
- 1 x NMI button
- 1 x Reset button
- 1 x LAN activity LED
- 1 x Storage activity LED
- 1 x System status LED

## Rear I/O

2 x USB 3.2 Gen1

- 1 x Mini-DP
- 1 x RJ45
- 1 x MLAN
- 1 x ID button with LED

Speed and bandwidth: PCIe Gen4 x4 or SATA 6Gb/s or SAS 12Gb/s

#### TPM

1 x TPM header with SPI interface

- Optional TPM2.0 kit: CTM010

## **Power Supply**

1+1 1600W 80 PLUS Platinum redundant power supplies

#### AC Input:

- 100-120V~/ 12A, 50/60Hz
- 200-240V~/ 10A, 50/60Hz

DC Input: (Only for China)

- 240Vdc/ 10A

#### DC Output:

- Max 1000W/ 100-120V~
- +12V/81.5A
- +12Vsb/ 2.5A
- Max 1600W/ 200-240V~ or 240Vdc Input
- +12V/ 133A
- +12Vsb/ 2.5A

Note: The default power supply is based on a basic system configuration. Please contact with technical representatives to determine the best power supply selection for your system configuration requirements and preferred efficiency.

## **System Management**

Aspeed® AST2600 management controller GIGABYTE Management Console (AMI MegaRAC SP-X) web interface

Dashboard HTML5 KVM

Sensor Monitor (Voltage, RPM, Temperature, CPU Status ...etc.) ory Data

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SEL Log in Linear Storage / Circular Storage Policy

Hardware Inventory

Fan Profile

System Firewall

**Power Consumption** 

Power Control

Advanced power capping

LDAP / AD / RADIUS Support Backup & Restore Configuration

Remote BIOS/BMC/CPLD Update

**Event Log Filter** 

User Management

Media Redirection Settings

**PAM Order Settings** 

SSL Settings

**SMTP Settings** 

# **OS Compatibility**

Please refer to OS compatibility table in support page

# System Fans

4 x 80x80x38mm (18,300rpm)

# **Operating Properties**

Operating temperature: 10°C to 35°C

Operating humidity: 8%-80% (non-condensing) Non-operating temperature: -40°C to 60°C

Non-operating humidity: 20%-95% (non-condensing)

#### Weight

Net Weight: 16 kg Gross Weight: 19 kg

#### **Packaging Dimensions**

732 x 588 x 285 mm

#### **Packaging Content**

- 1 x E263-Z30-AAD1
- 1 x CPU heatsink
- 1 x Mini-DP to D-Sub cable
- 1 x GPU power cable (2x PCle 8pin, 350mm)
- 1 x GPU power cable (2x PCle 8pin, 480mm)

Note: Rail kit not included. Please refer to optional parts for compatible rail kit.

# Part Numbers

- Barebone package: 6NE263Z30DR000AAD1\*
- Motherboard: 9MZ33DC0UR-000
- CPU heatsink: 25ST1-553201-M1R
- M.2 heatsink: 12SP2-11000E-00R
- Front panel board CFP2001: 9CFP2001NR-00
- Backplane board CBP2022: 9CBP2022NR-00
- Fan module: 25ST2-88382T-S1R
- Riser card CRS201H: 9CRS201HNR-00
- Riser card CRS201M: 9CRS201MNR-00
- Mini-DP to D-Sub cable: 25CRN-200801-K1R
- GPU power cable (2x PCIe 8pin, 350mm): 25CRI-350305-Y4R
- GPU power cable (2x PCIe 8pin, 480mm): 25CRI-480300-Y4R
- Power supply: 25EP0-216008-L0S

# **Optional parts:**

- 2-Section Rail kit: 25HB2-3A0204-K0R
- A100/MI210 power cable (CPU 8pin, 350mm): 25CRI-350100-Y4R
- A100/MI210 power cable (CPU 8pin, 480mm): 25CRI-480101-Y4R
- H100 power cable (12VHPWR, 360mm); 25CRI-360102-Y4R
- H100 power cable (12VHPWR, 490mm): 25CRI-490102-Y4R

- \* Advertised performance is based on maximum theoretical interface values from respective Chipset vendors or organization who defined the interface specification. Actual performance may vary by system configuration.
- \* All trademarks and logos are the properties of their respective holders.
- \* Due to standard PC architecture, a certain amount of memory is reserved for system usage and therefore the actual memory size is less than the stated amount.

<sup>\*</sup> The entire materials provided herein are for reference only. GIGABYTE reserves the right to modify or revise the content at anytime without prior notice.